

Closing the Loop:

Incorporation of Sort Floor Data to Improve Probe Card Performance

Presented By:

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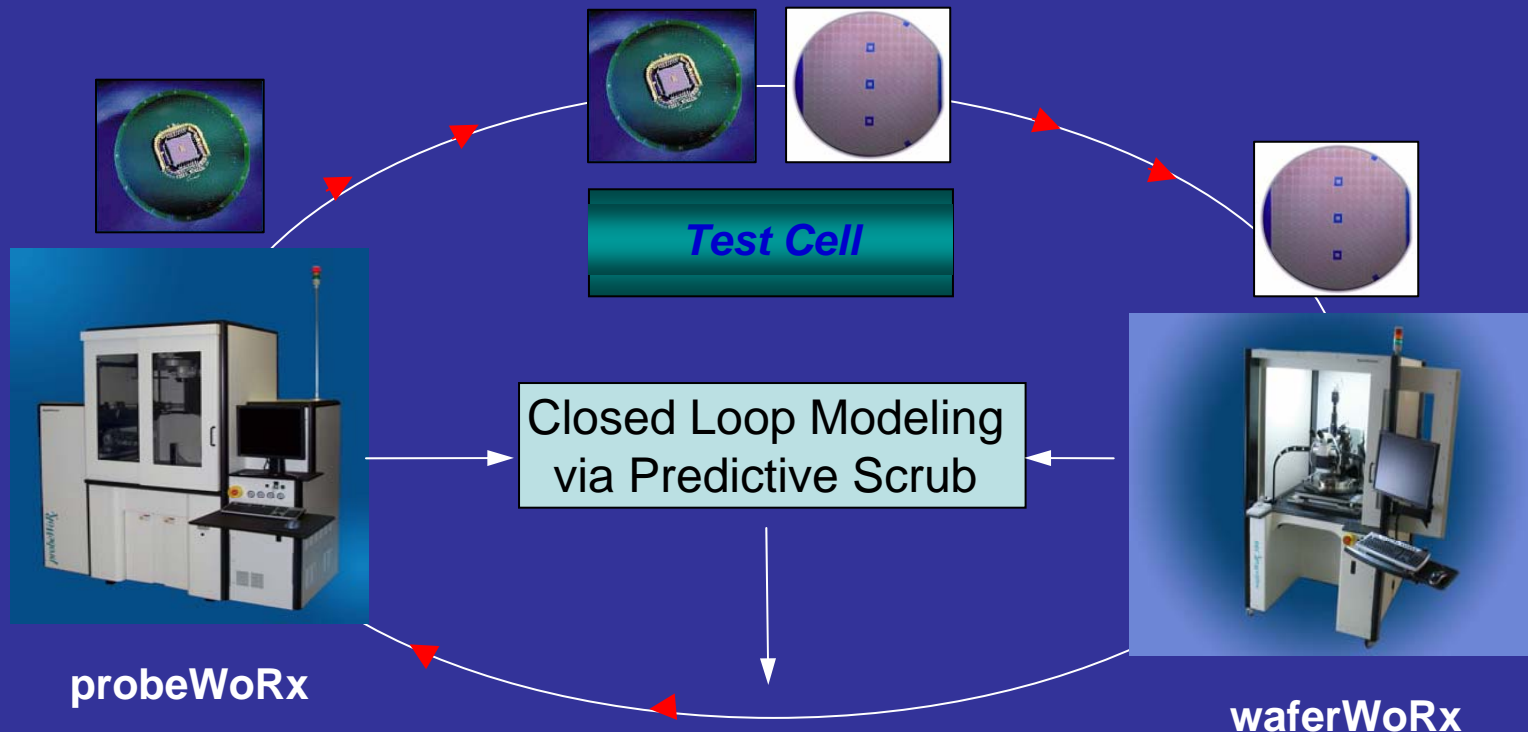


What is the best method to optimize the performance of the probe card in the test cell?

- Cannot directly measure probe card performance within the test cell
 - The wafer is not transparent
 - Probe Card Analyzer (PCA) qualifies probe card prior to wafer test
 - Probe Mark Analyzer (PMA) quantifies the probe card performance post probe via scrub mark analysis
- PCA and Test Cell environments are inherently different
 - Friction
 - Overtravel differences (Deflection, Test Interface)
 - Temperature differences

Introducing a Closed Loop Probing Process

Closing the Loop



- **Build Closed Loop Model**

- Measure probe card on a PCA
- Probe wafers in the test cell
- Measure the probe card performance at test with PMA
- Analyze PCA and PMA data to build Closed Loop Model

- **Apply Closed Loop Model in PCA to deliver optimized probe cards to the test cell via predicted probe card measurements**

Scrub Measurement Correlation

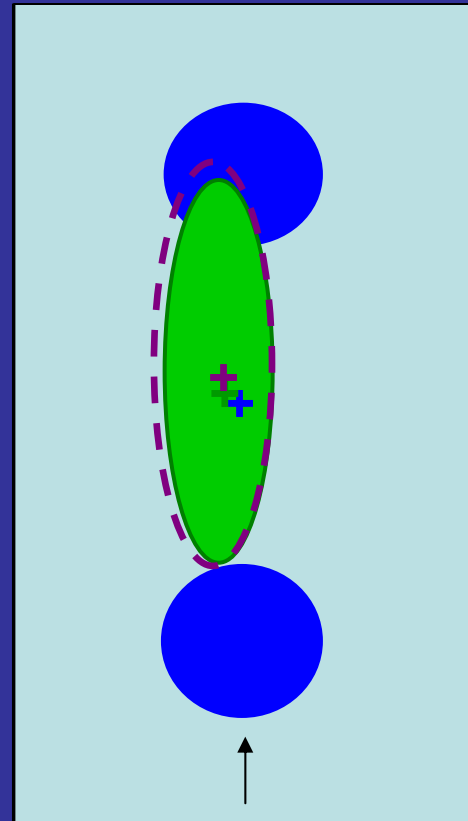
Closing the Loop

1) PCA Measurement

2) Quantify PCA differences with Test Cell

3) Develop Closed Loop Model

4) Implement Predictive Scrub with PCA





Overtravel Position (OT)

Center Position

No Overtravel Position (NOT)

 PCA measurement

 waferWoRx measurement

 Predicted Scrub

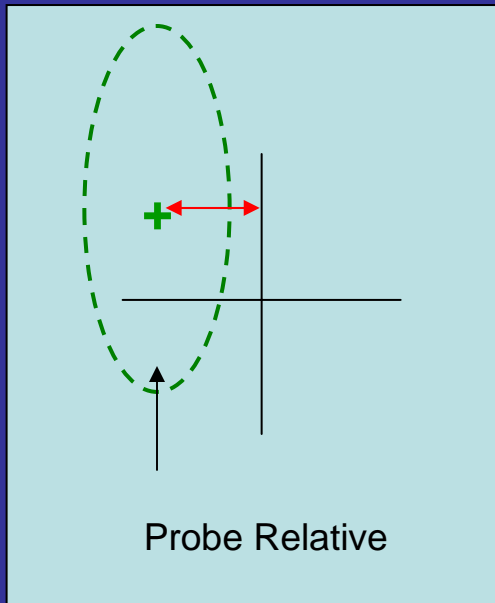
Validate Closed Loop Metrology improvements across a range of conditions

- Various probe card technologies
- Different tester types & different probers
- Temperature range (cold, ambient, hot)

Test Procedure

- Run Planarity & Alignment on PCA
- Probe wafer at ambient
- Probe wafer at temperature
- Run scrub mark analysis with PMA
- PCA and PMA data analysis to create predictive scrub model
- Apply predictive scrub model to enhance wafer scrub results

Perpendicular Position



Perpendicular Position:
PCA vs. Wafer Scrub
correlation

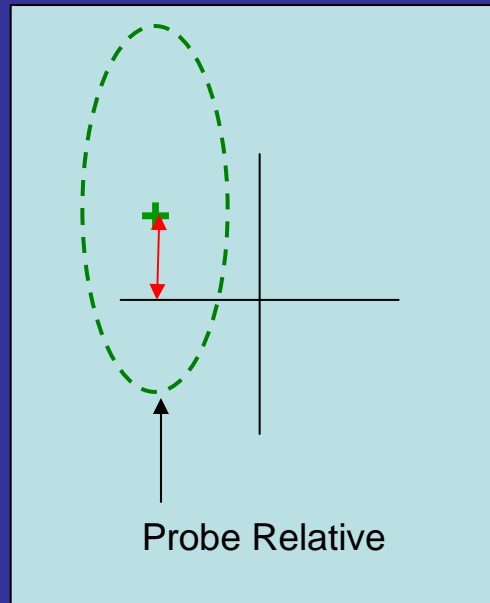
Sensitive to

- Temperature

Insensitive to

- Overtravel Accuracy
- Friction of surface
- Wafer Scrub mechanics
- Probe tip size

Parallel Position

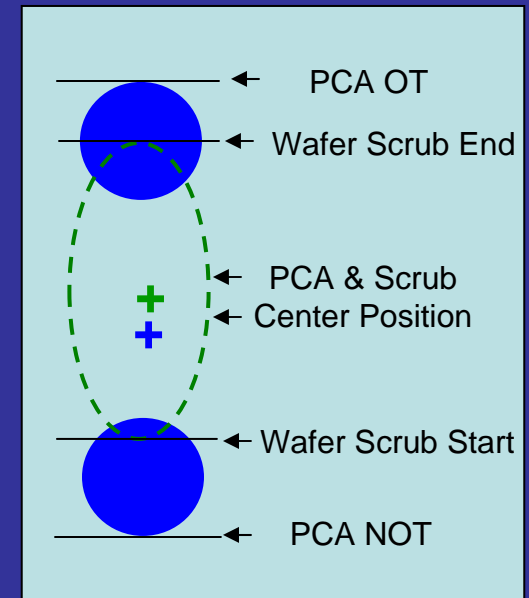


Parallel Position:
PCA vs. Wafer Scrub
correlation

Sensitive to

- Temperature
- Overtravel Accuracy
- Friction of surface
- Wafer Scrub mechanics
- Probe tip size
- Tier

Measurement Positions

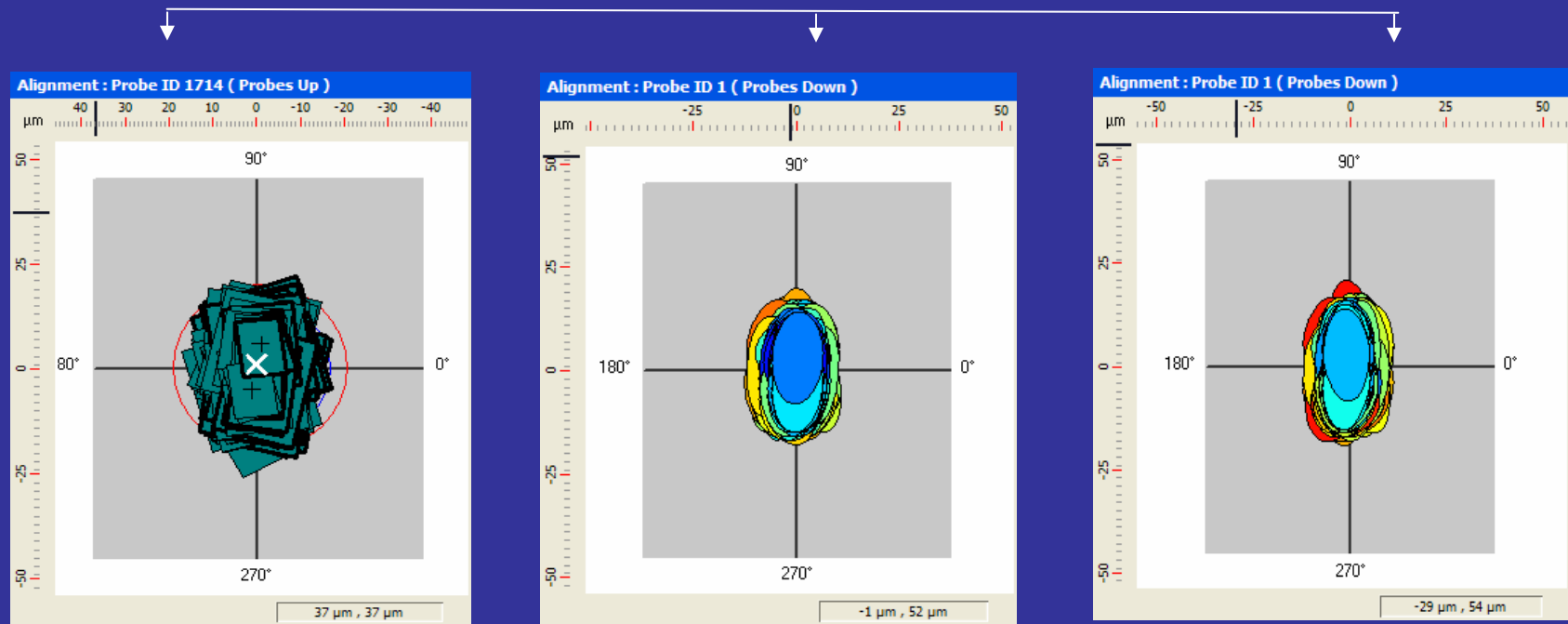


- PCA measurement
- PMA @ Ambient
- PMA @ Temperature
- Predictive Scrub

Scrub Signatures - Case Study #1

Closing the Loop

- Superpad display of probes and scrubs
 - Medium size array (< 100mm, ~4000 probes)

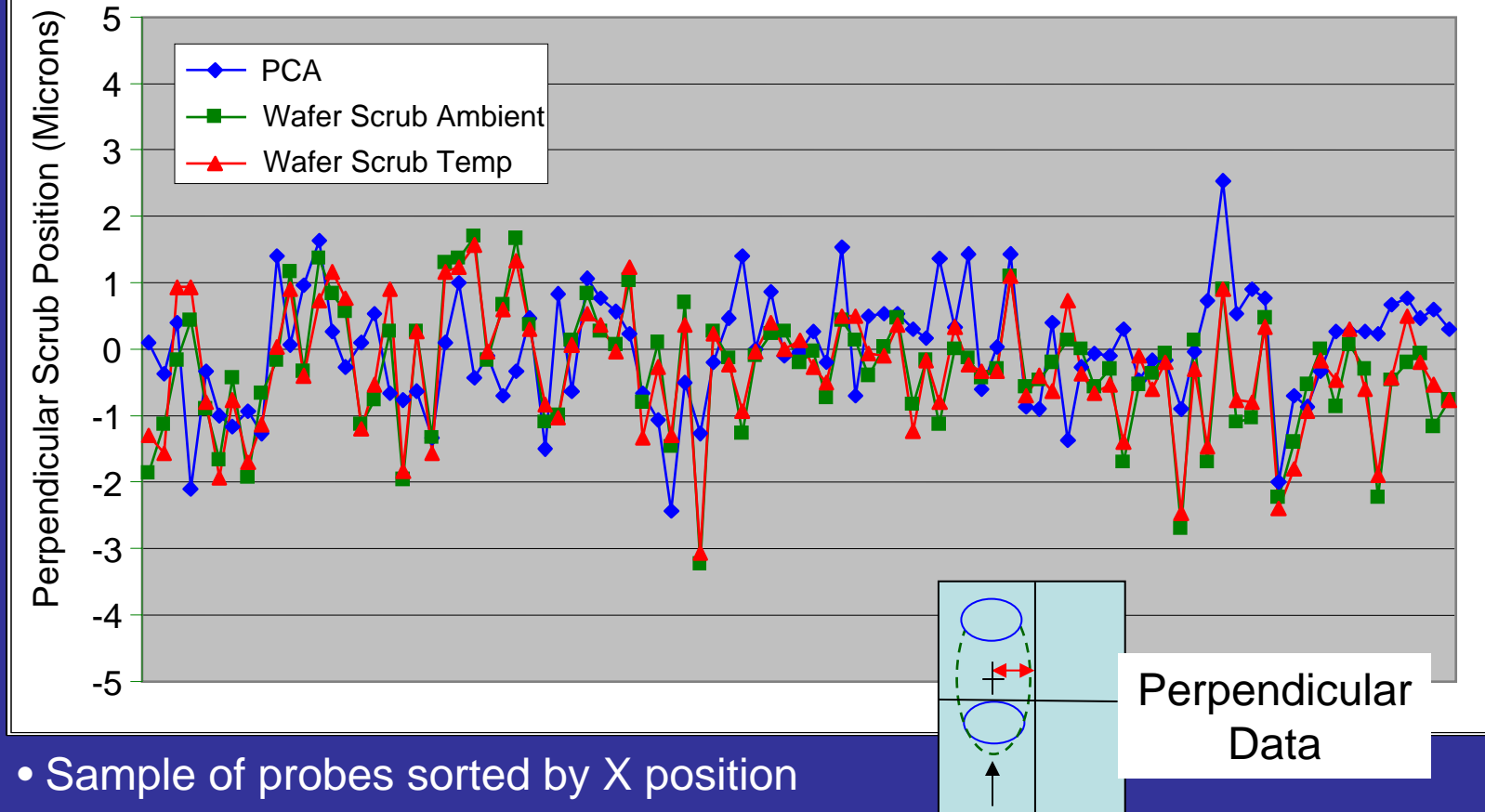


PCA
all probes

PMA *ambient*
all probes
prober errors removed

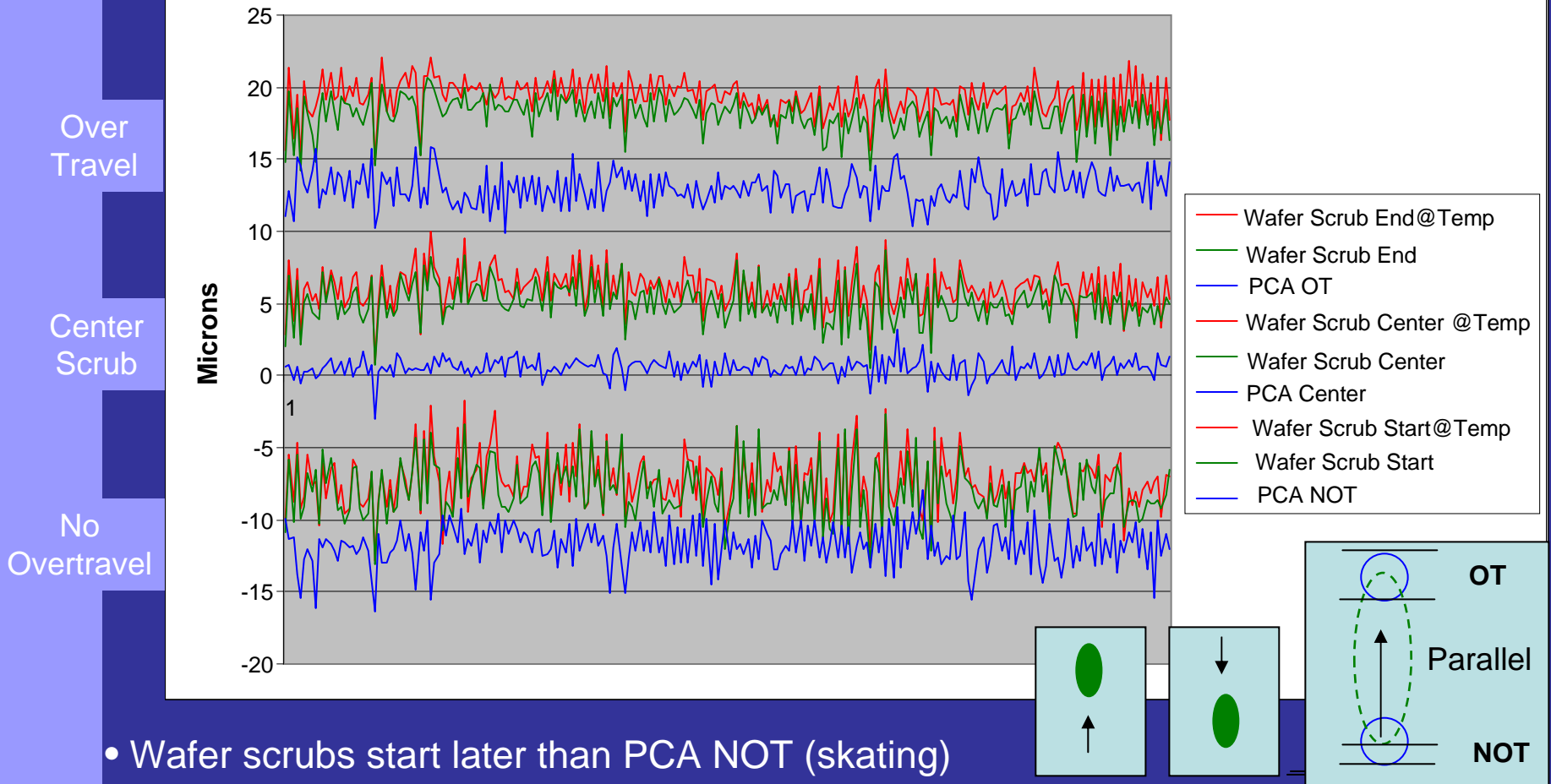
PMA @ *temperature*
all probes
prober errors removed

Probe Card Scaling: perpendicular scrub positions PCA Scrubs vs Wafer Scrubs



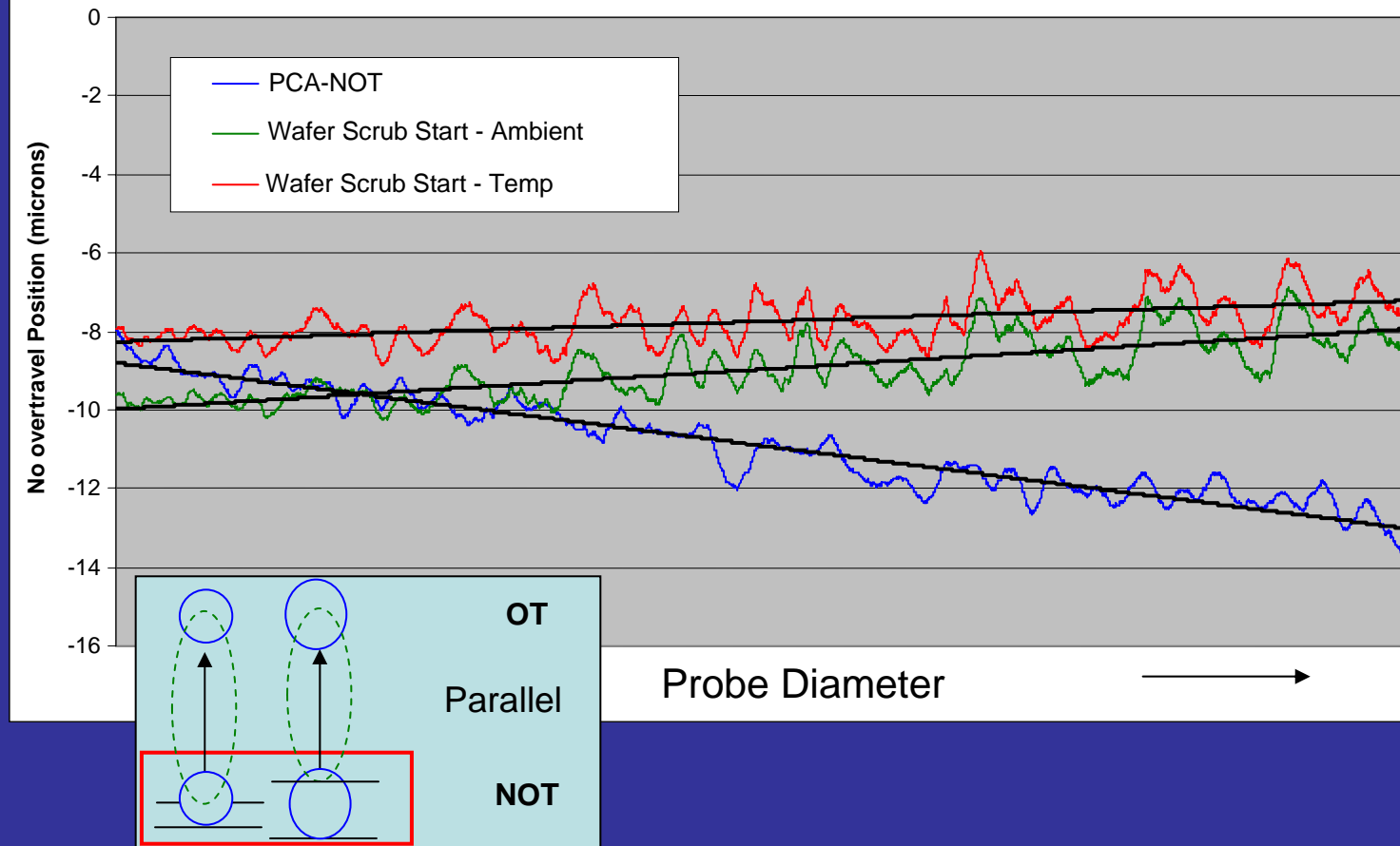
- Sample of probes sorted by X position
- Wafer scrubs at ambient and temperature have minimal scaling effects
- Good correlation between PCA and wafer scrubs: 2.1 microns @ 3 sigma

PCA Scrubs vs. Wafer Scrubs

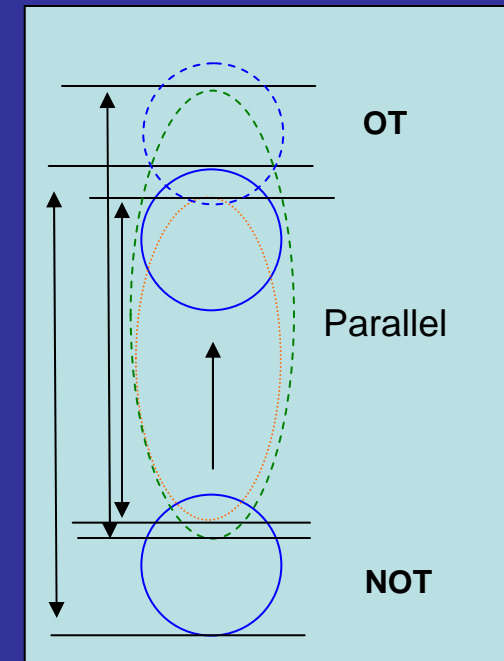
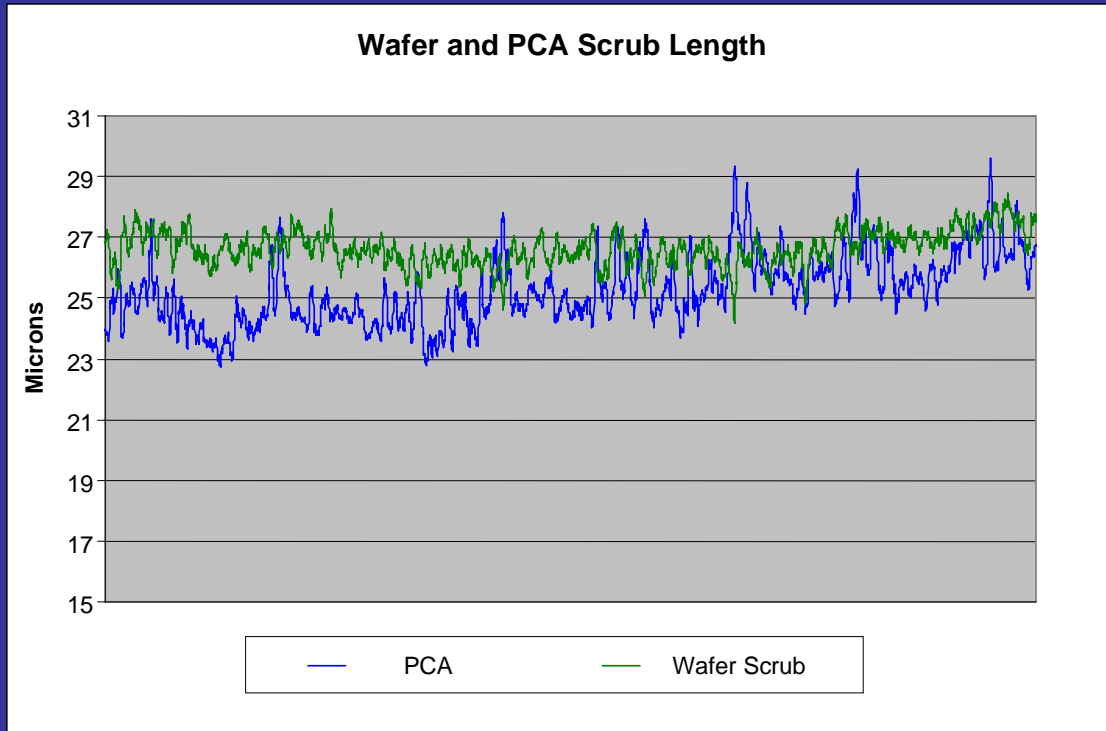


- Wafer scrubs start later than PCA NOT (skating)
- Wafer scrub end positions are farther than PCA OT (scrub length)
- Overall scrub length is the same (indicates OT differential between PCA & test cell)
- Center position correlation: 7.2 micron @ 3 sigma

PCA NOT Edge Position vs. Wafer Scrub Start Position



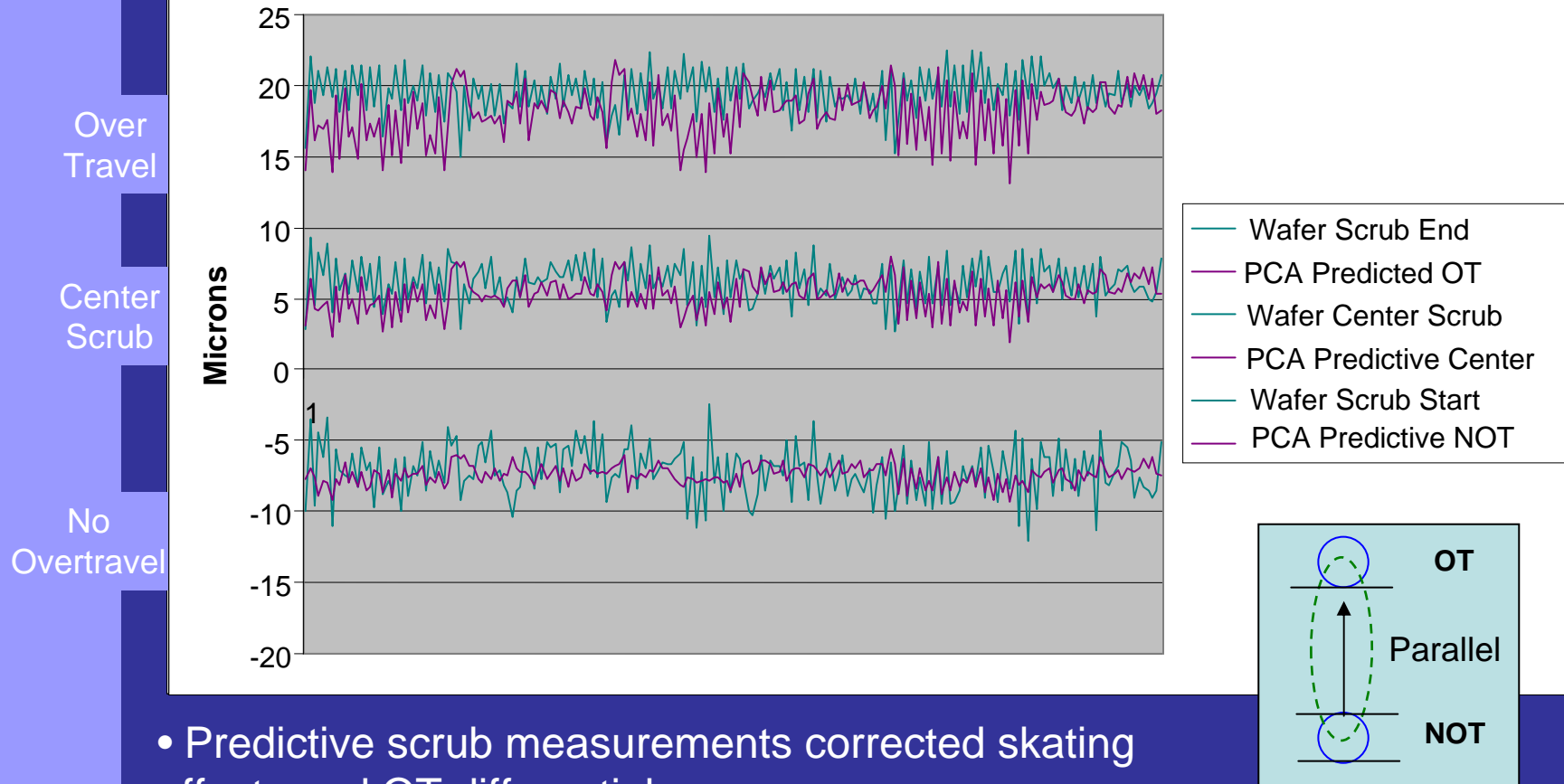
- PCA Scrub signature starts “earlier” the larger the probe diameter
- Wafer Scrub signature begins “later” the larger the probe diameter



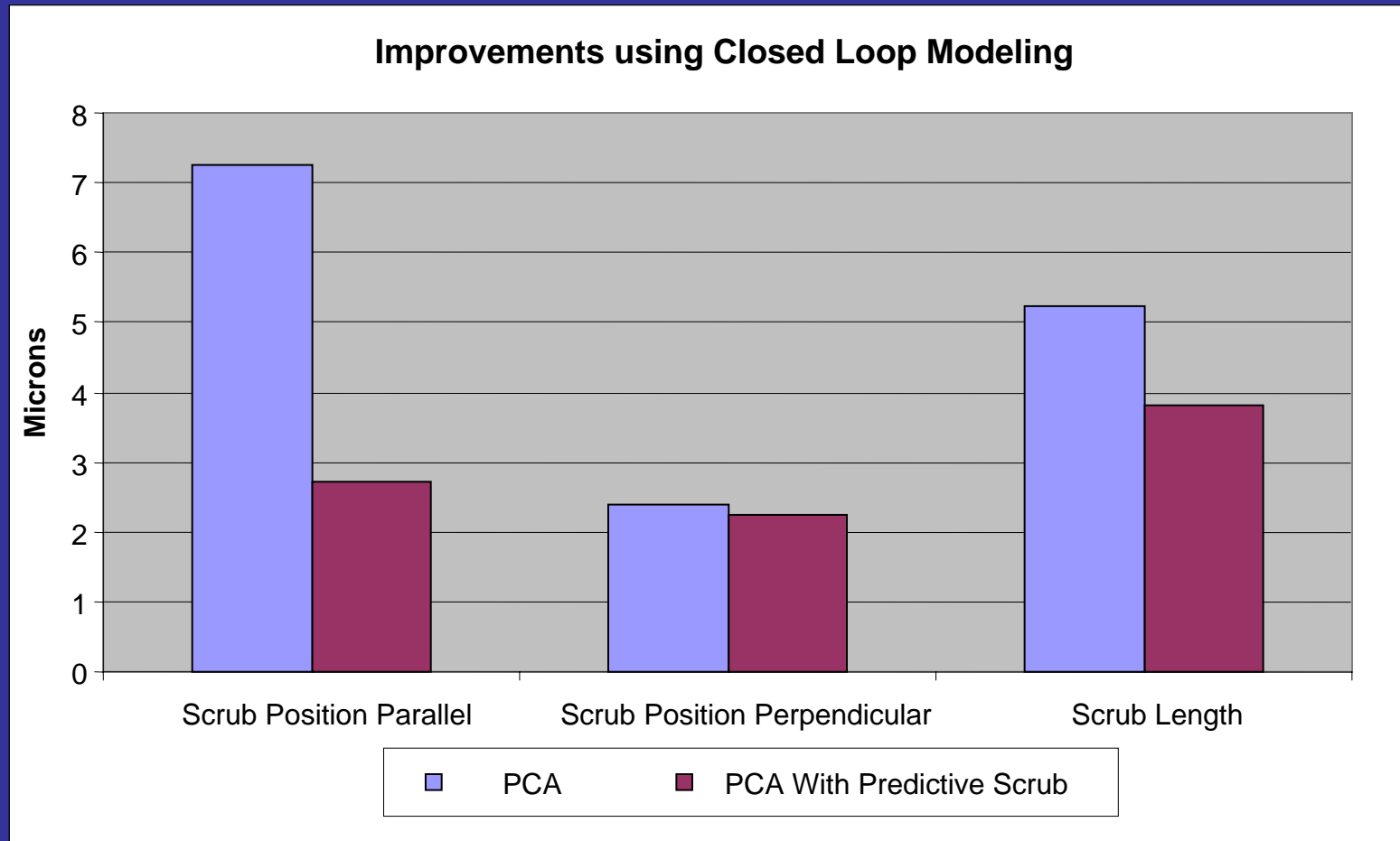
- Wafer and PCA scrub lengths are roughly equal
- Expect wafer scrubs to be shorter than PCA due to skating
- Therefore OT on the test cell is larger than OT on the PCA

Closed Loop Model Results: Case Study #1 *Closing the Loop*

Predictive PCA Scrubs vs. Wafer Scrubs



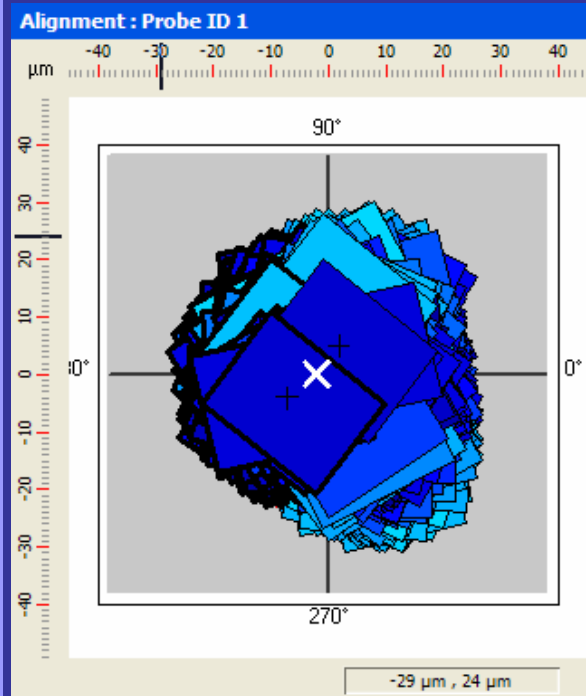
- Predictive scrub measurements corrected skating effects and OT differential
- Predicted Scrub Position correlation: 2.6 microns
- Predicted Scrub Length correlation: 3.7 microns



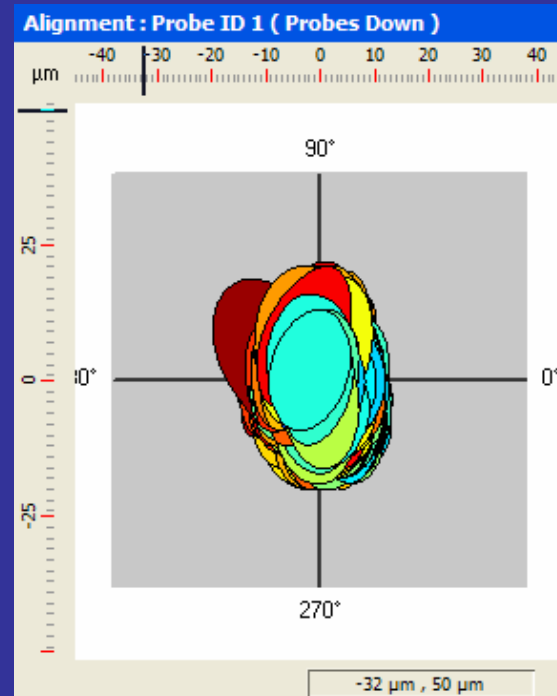
- Closed Loop Modeling improvements
 - 2.7X improvement in Scrub Position predictability
 - 1.4X improvement in Scrub Length predictability

Scrub Signatures - Case Study #2

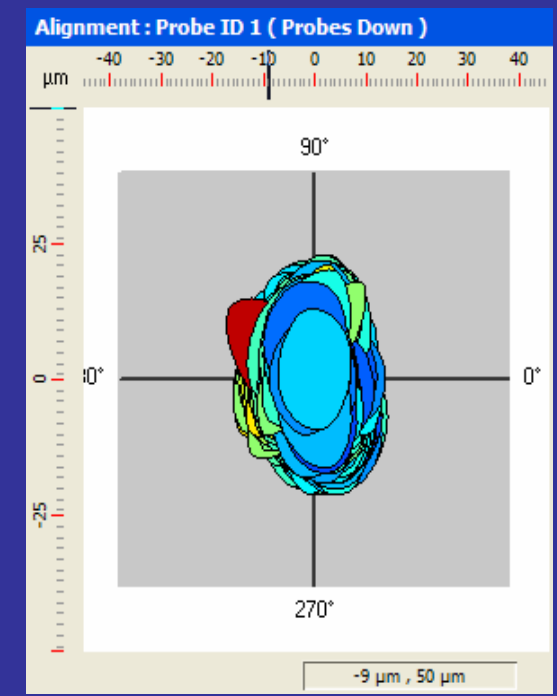
Closing the Loop



PCA – all probes

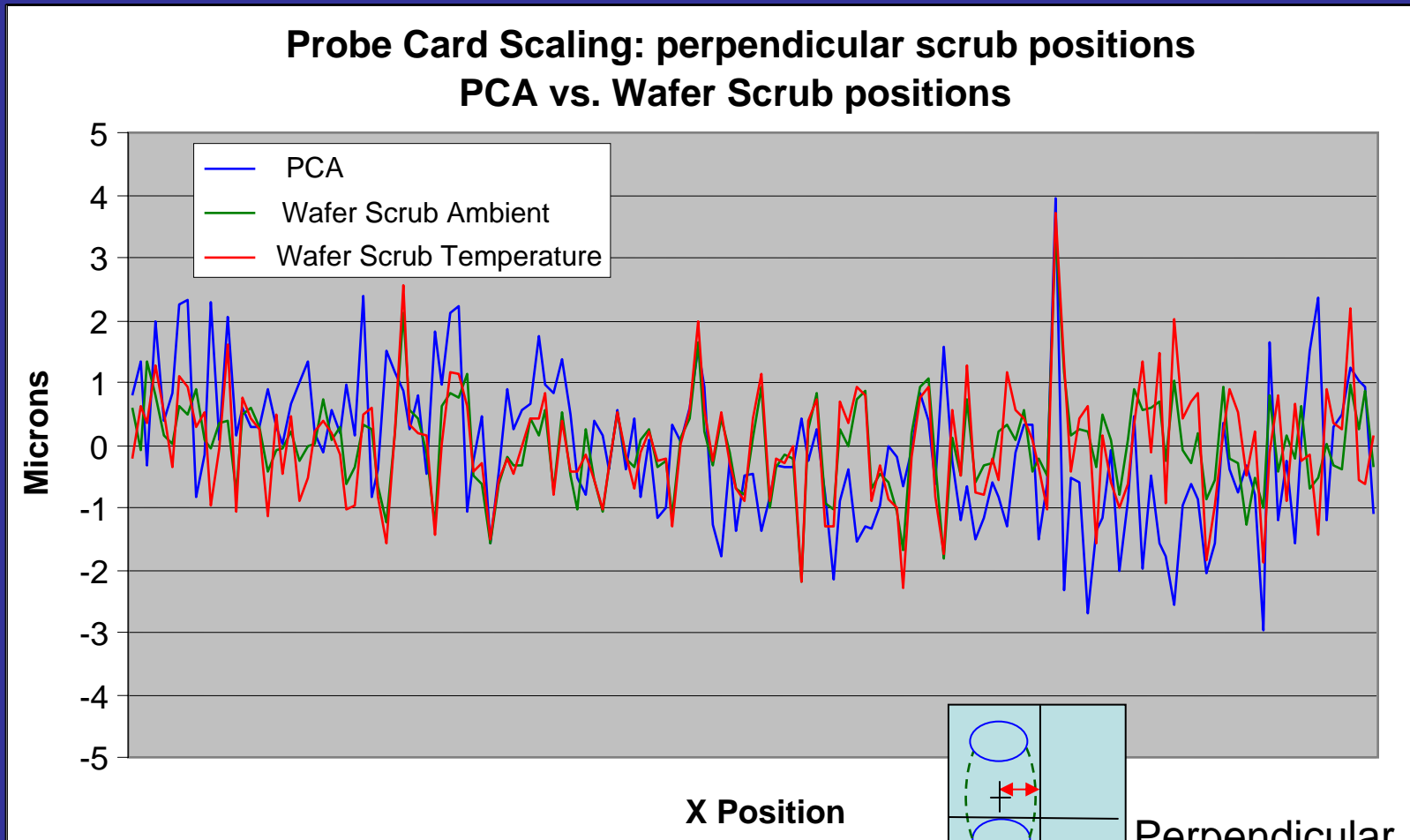


PMA @ ambient
All probe scrubs w/prober
errors removed



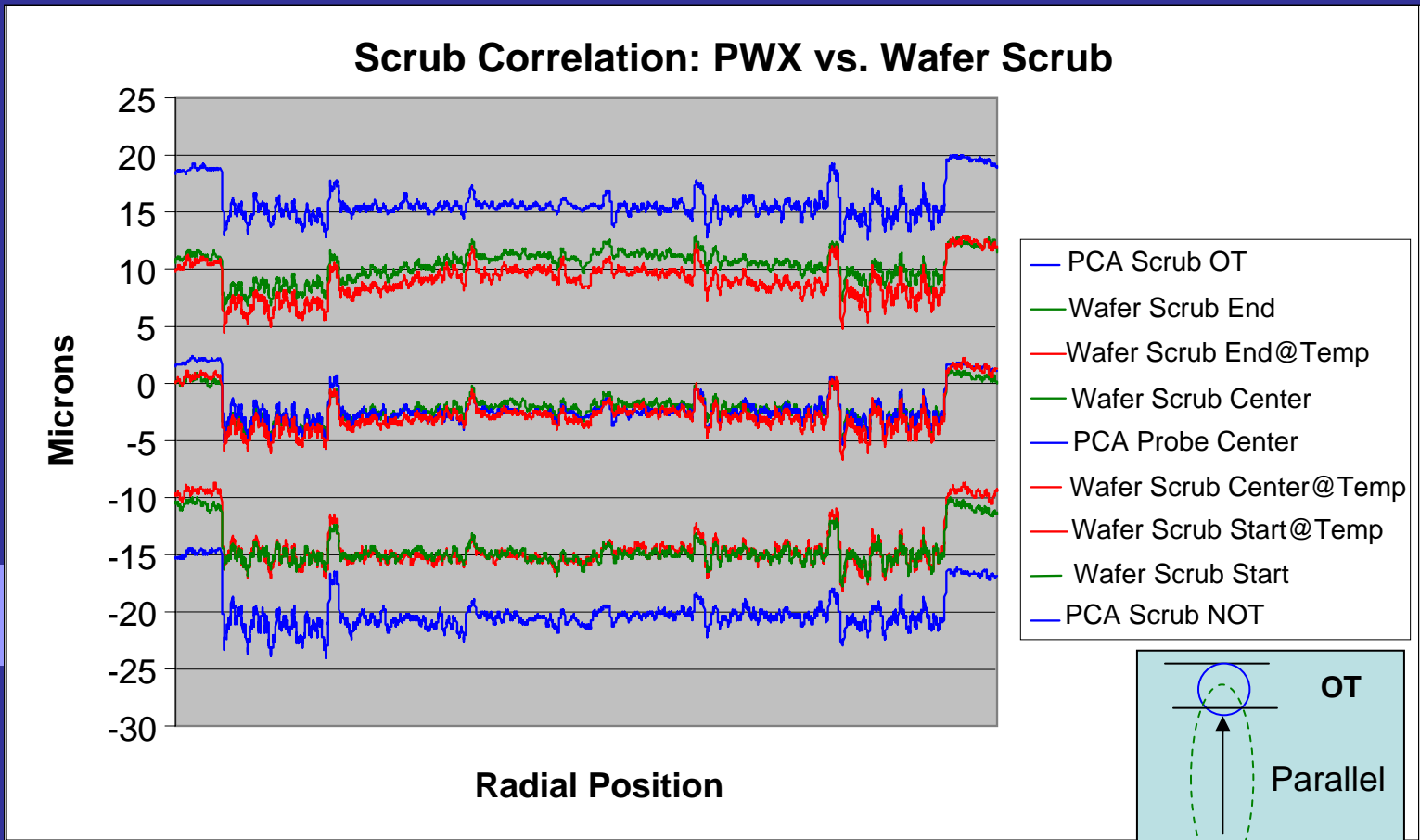
PMA @ temp
All probe scrubs w/prober
errors removed

- Medium size array (< 100mm, ~4000 probes)
- PCA scrub signature is larger than wafer scrub signature
- Ambient and Temperature wafer scrub signatures are very similar

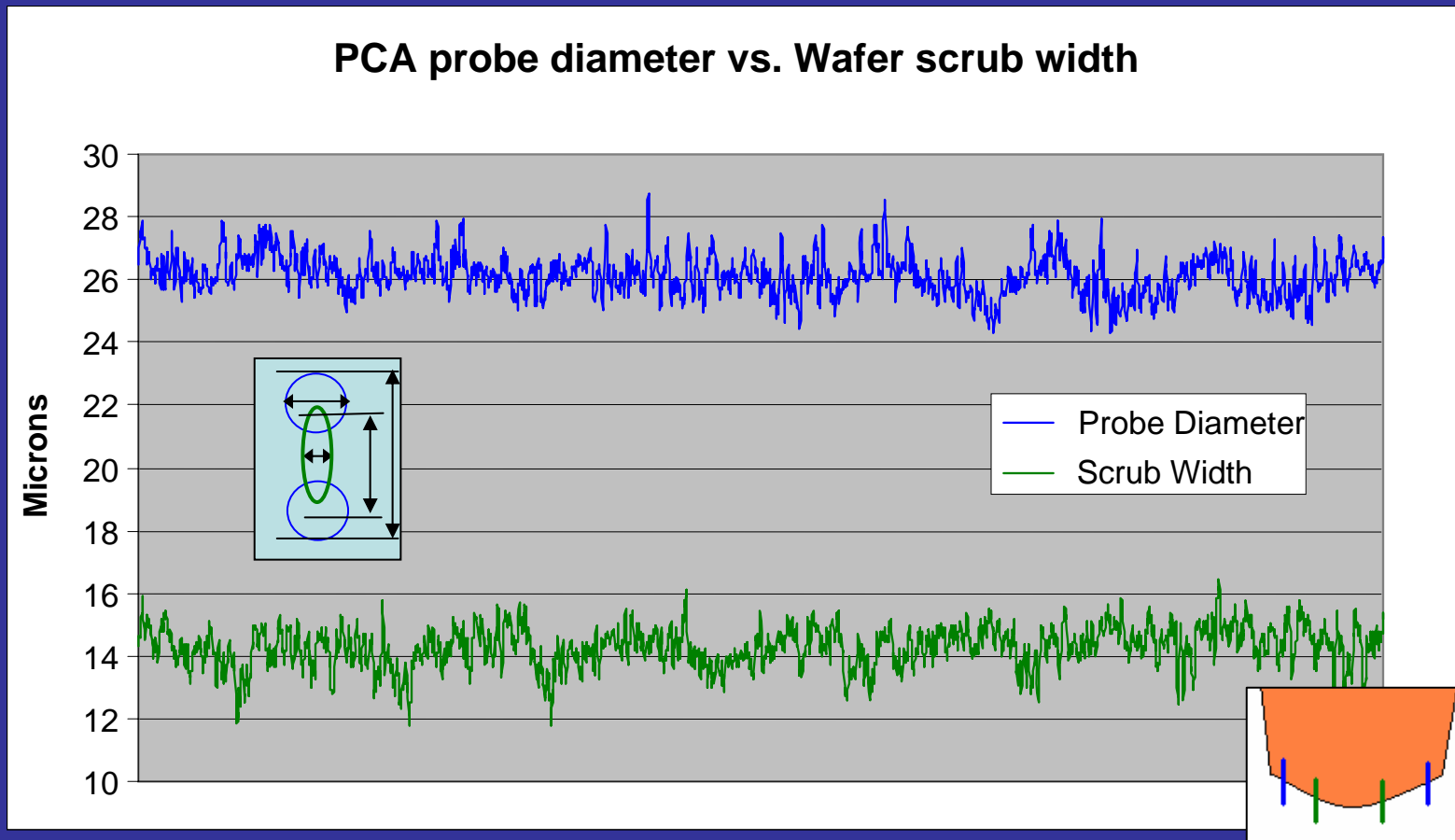


- Sample of probes sorted by X position
- Wafer scrubs at ambient and temp have minimal scaling effects
- Good correlation between PCA and wafer scrubs: 2.2 microns @ 3 sigma

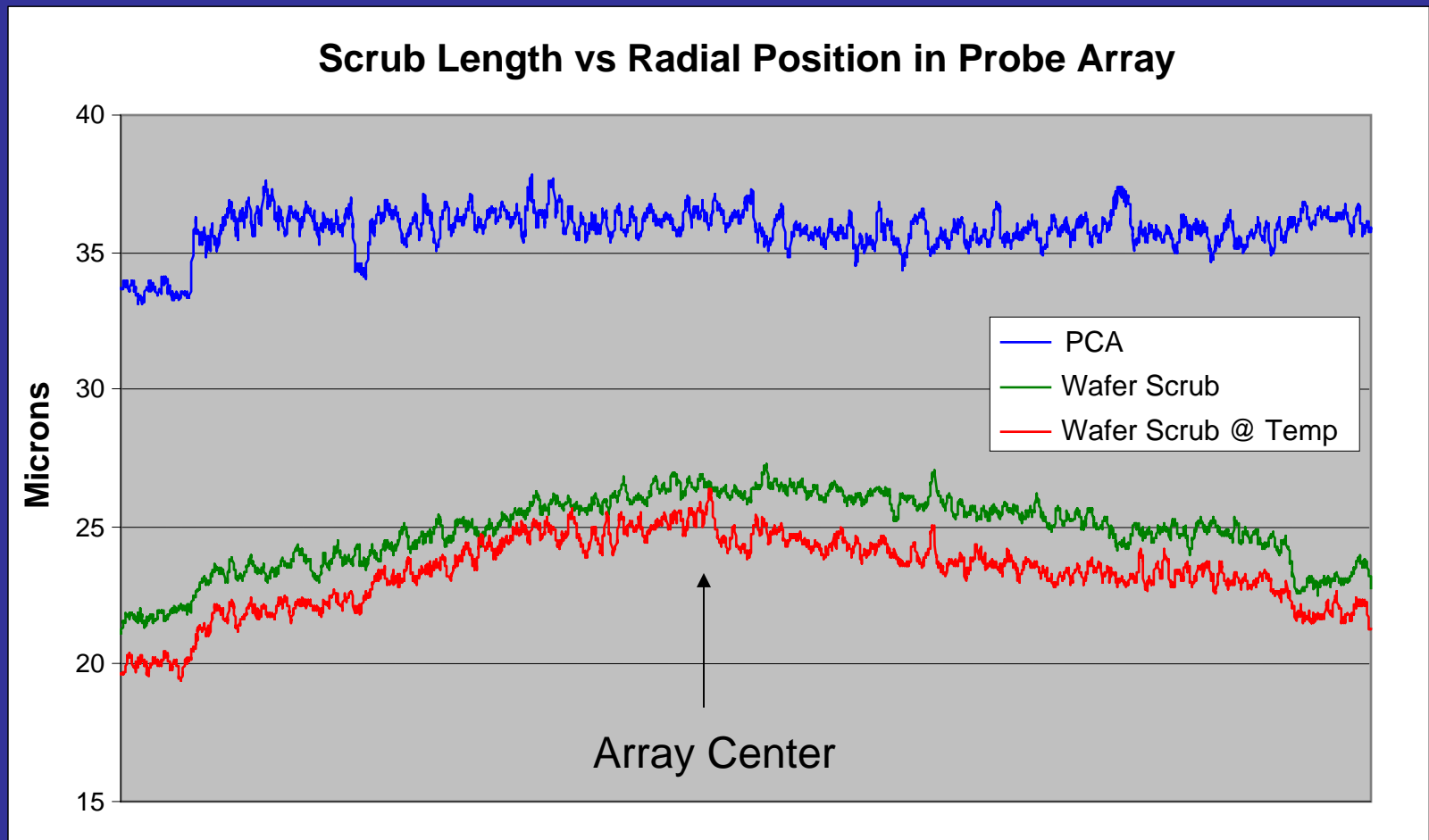
Over Travel
Center Scrub
No Overtravel



- Probes sorted by probe distance to center of array
- Wafer and PCA Scrub Centers correlate to 2.5 microns @ 3 sigma
- Wafer Scrub Lengths are significantly shorter (11 microns)
- Wafer Scrubs start later by ~ 6 microns
- Wafer Scrub lengths are longer in the middle of the card



- Wafer Scrub width is 12 microns less than the PCA probe diameter
- Shape of probe - PCA optical size vs. Wafer scrub size
- Wafer Scrub length is also 12 microns less than the PCA scrub length

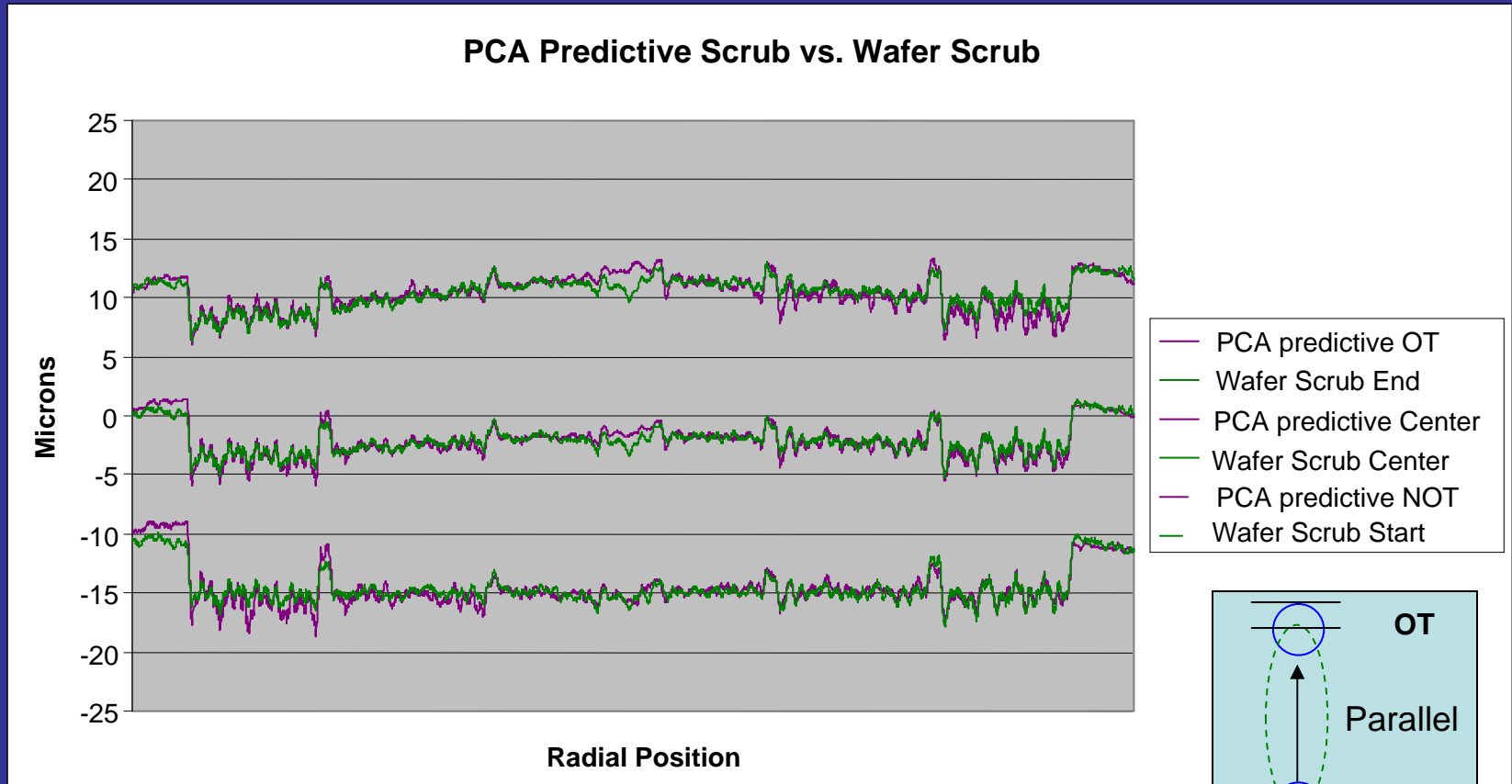


- Probes in the center of the probe card are scrubbing farther on the wafer
- PCA scrub lengths are relatively flat as a function of radius

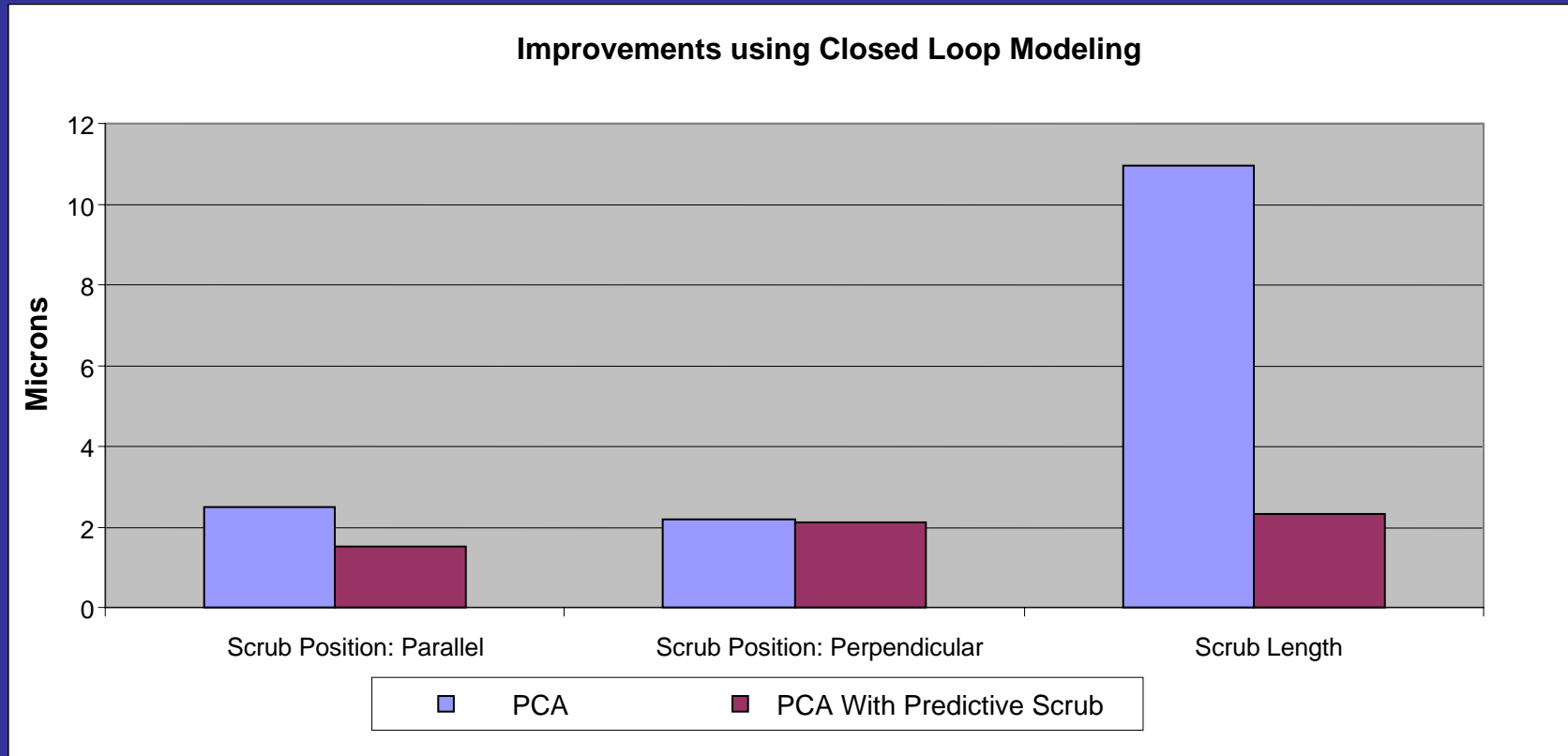
Over
Travel

Center
Scrub

No
Overtravel



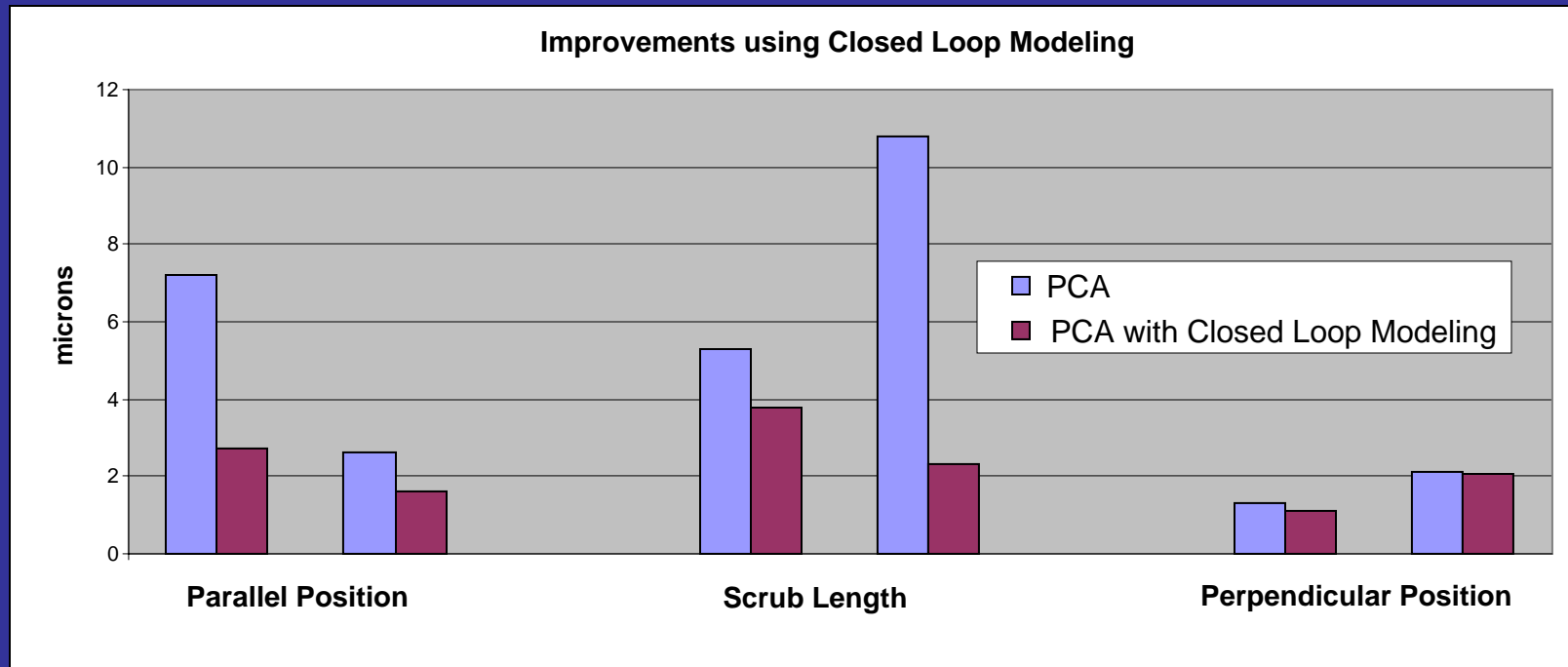
- Probes sorted by probe radial distance from array center
- Scrub Length correlation = 11 microns @ 3 sigma
- With predictive scrub: Scrub Length correlation = 2.3 microns @ 3 sigma
- With predictive scrub: Scrub Center correlation = 1.5 microns @ 3 sigma



- **Closed Loop Modeling improvements**

 - 1.6X improvement in Parallel Scrub Position

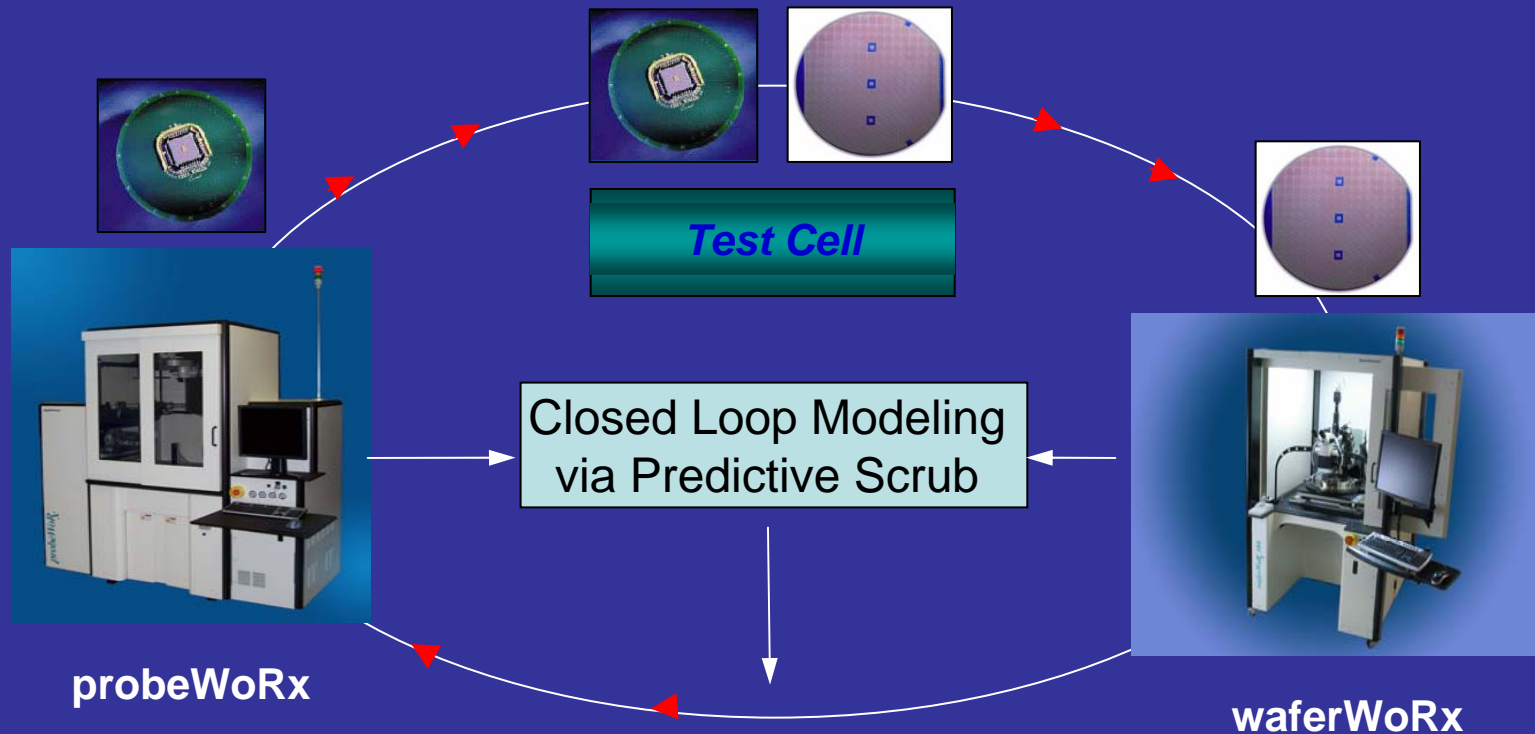
 - 4.7X improvement in Scrub Length



1. Good results between PCA and test cell when data measurement are insensitive to differences
2. Closed Loop Modeling enables significant improvements for Scrub Length and Scrub Position
3. Closed Loop Model enabled PCA can deliver optimized probe cards to the test cell via predicted probe card measurements

What is the best method to optimize the performance of the probe card in the test cell?

- Build Closed Loop Model
- Use a Closed Loop Model enabled PCA to deliver optimized probe cards to the test cell via predicted probe card measurements



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